

7MBR35XPA120-50

IGBT Modules

Power Module(X series)
1200V / 35A / PIM

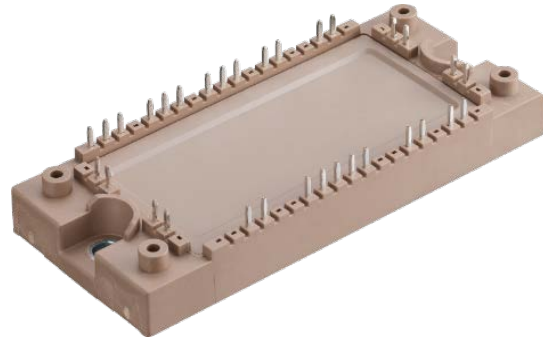
□ **Features**

- Low $V_{CE(sat)}$
- Compact Package
- P.C.Board Mount Module
- Converter Diode Bridge Dynamic Brake Circuit
- RoHS compliant Product

□ **Applications**

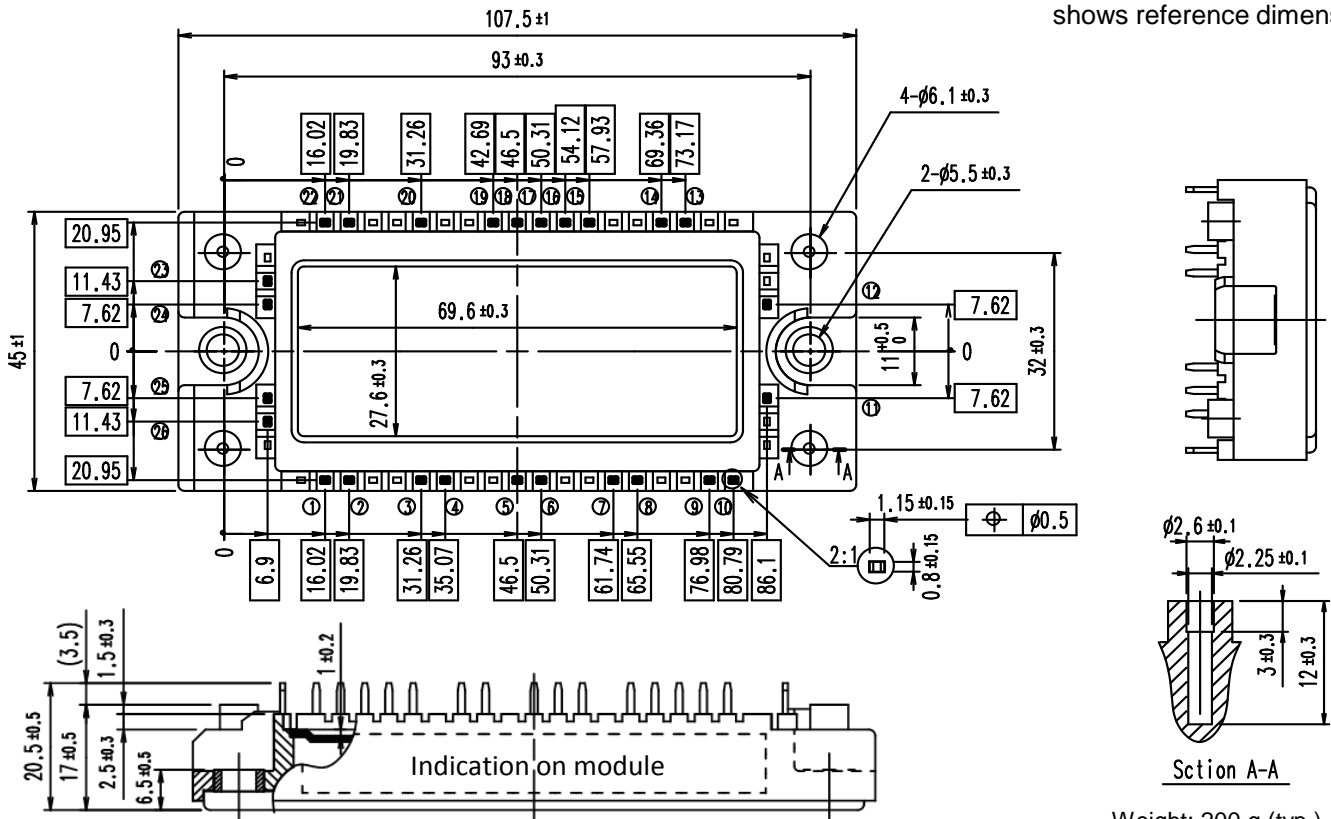
- Inverter for Motor Drive
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply

□ **Typical appearance**

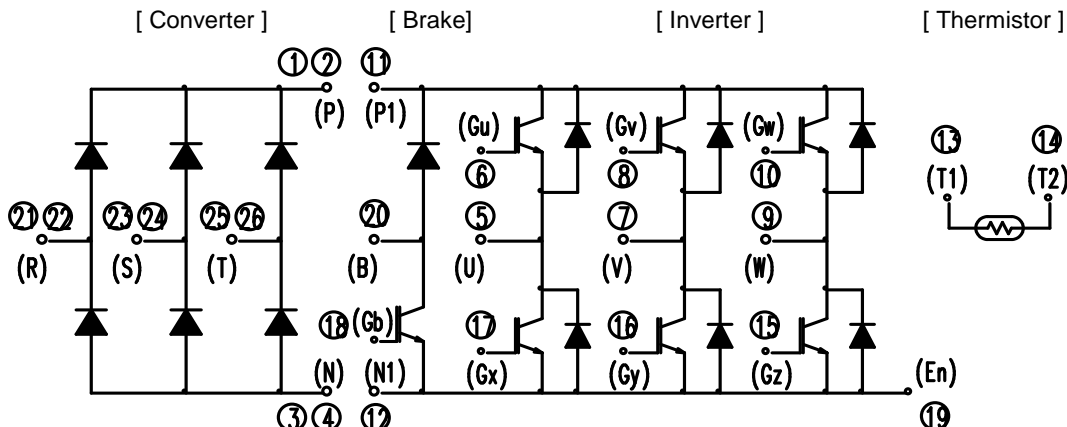


□ **Outline drawing (Unit : mm)**

□ shows theoretical dimension.
 □ shows reference dimension.



□ **Equivalent circuit**



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□ Maximum ratings (at $T_c = 25^\circ\text{C}$ unless otherwise specified)

Items		Symbols	Conditions		Maximum ratings	Units	
Inverter	Collector-Emitter voltage	V_{CES}			1200	V	
	Gate-Emitter voltage	V_{GES}			± 20	V	
	Collector current	I_C	Continuous	$T_c=100^\circ\text{C}$	35	A	
		I_C pulse	1ms		70		
	Forward current	I_F	Continuous		35		
		I_F pulse	1ms		70		
Collector power dissipation	P_C	1 device		200	W		
Brake IGBT	Collector-Emitter voltage	V_{CES}			1200	V	
	Gate-Emitter voltage	V_{GES}			± 20	V	
	Collector current	I_C	Continuous	$T_c=100^\circ\text{C}$	25	A	
		I_C pulse	1ms		50		
Collector power dissipation	P_C	1 device		170	W		
Brake FWD	Forward current	I_F	Continuous		15	A	
		I_{FRM}	1ms		30		
	Repetitive peak reverse voltage	V_{RRM}			1200	V	
Repetitive peak reverse voltage	V_{RRM}			1600	V		
Converter	Average output current	I_O	Three-phase full wave rectified current	$T_c=80^\circ\text{C}$	35	A	
	Surge current (Non-Repetitive) (*1)	I_{FSM}	$t=10\text{ms}$, Half sine wave form	$T_{vj}=25^\circ\text{C}$	470	A	
				$T_{vj}=150^\circ\text{C}$	385		
	I^2t (Non-Repetitive) (*1)	I^2t			$T_{vj}=25^\circ\text{C}$	1105	A ² s
$T_{vj}=150^\circ\text{C}$					750		
Junction temperature		T_{vj}	Inverter, Brake		175	°C	
			Converter		150		
Operating junction temperature (under switching conditions)		T_{vjop}	Inverter, Brake		175		
			Converter		150		
Case temperature		T_c			125		
Storage temperature		T_{stg}			-40 ~ 125		
Isolation voltage	between terminals and copper base (*2)	V_{iso}	A.C. : 1min.		2500		Vrms
	between thermistor and others (*3)						
Screw torque (*4)	Mounting	-	M5		6.0	N·m	

(*1) T_{vj} : Temperature at test start.

(*2) All terminals should be connected together during the test.

(*3) Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

(*4) Recommendable value : Mounting 2.5 ~ 6.0 N·m (M5)

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□ Electrical characteristics (at $T_{vj}=25^{\circ}\text{C}$ unless otherwise specified)

Items	Symbols	Conditions	Characteristics			Units			
			min.	typ.	max.				
Zero Gate voltage collector current	I_{CES}	$V_{GE} = 0\text{V}$ $V_{CE} = 1200\text{V}$	-	-	50	μA			
Gate-Emitter leakage current	I_{GES}	$V_{CE} = 0\text{V}$ $V_{GE} = +20/-20\text{V}$	-	-	100	nA			
Gate-Emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = 20\text{V}$ $I_C = 35\text{mA}$	6.0	6.5	7.0	V			
Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	$V_{GE} = 15\text{V}$ $I_C = 35\text{A}$	$T_{vj}=25^{\circ}\text{C}$	-	1.65	2.10	V		
			$T_{vj}=25^{\circ}\text{C}$	-	1.50	1.95			
	$T_{vj}=125^{\circ}\text{C}$		-	1.85	-				
	$T_{vj}=150^{\circ}\text{C}$		-	1.95	-				
	$T_{vj}=175^{\circ}\text{C}$		-	2.00	-				
Internal Gate resistance	r_g	-	-	0	-	Ω			
			Capacitance	C_{ies}	$V_{CE} = 10\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$	-	3.7	-	nF
						C_{oes}	-	0.13	
C_{res}	-	0.03					-		
Gate charge	Q_G	$V_{CC} = 600\text{V}$ $V_{GE} = -15 \rightarrow +15\text{V}$ $I_C = 35\text{A}$	-	240	-	nC			
Forward voltage	V_F (terminal)	$I_F = 35\text{A}$	$T_{vj}=25^{\circ}\text{C}$	-	1.95	2.40	V		
			$T_{vj}=25^{\circ}\text{C}$	-	1.80	2.25			
	V_F (chip)		$T_{vj}=125^{\circ}\text{C}$	-	1.85	-			
			$T_{vj}=150^{\circ}\text{C}$	-	1.80	-			
			$T_{vj}=175^{\circ}\text{C}$	-	1.75	-			
Switching time (*1)	$t_{d(on)}$	$V_{CC} = 600\text{V}$ $I_C, I_F = 35\text{A}$ $L_s = 30\text{nH}$ $V_{GE} = +15/-15\text{V}$ $R_G = 30\ \Omega$	$T_{vj}=25^{\circ}\text{C}$	-	0.10	-	μs		
			$T_{vj}=125^{\circ}\text{C}$	-	0.10	-			
			$T_{vj}=150^{\circ}\text{C}$	-	0.11	-			
			$T_{vj}=175^{\circ}\text{C}$	-	0.11	-			
	t_r		$T_{vj}=25^{\circ}\text{C}$	-	0.04	-			
			$T_{vj}=125^{\circ}\text{C}$	-	0.05	-			
			$T_{vj}=150^{\circ}\text{C}$	-	0.05	-			
			$T_{vj}=175^{\circ}\text{C}$	-	0.05	-			
	$t_{d(off)}$		$T_{vj}=25^{\circ}\text{C}$	-	0.23	-			
			$T_{vj}=125^{\circ}\text{C}$	-	0.27	-			
			$T_{vj}=150^{\circ}\text{C}$	-	0.27	-			
			$T_{vj}=175^{\circ}\text{C}$	-	0.27	-			
t_f	$T_{vj}=25^{\circ}\text{C}$	-	0.12	-					
	$T_{vj}=125^{\circ}\text{C}$	-	0.18	-					
	$T_{vj}=150^{\circ}\text{C}$	-	0.20	-					
	$T_{vj}=175^{\circ}\text{C}$	-	0.21	-					
Reverse recovery time	t_{rr}	$T_{vj}=25^{\circ}\text{C}$	-	0.10	-				
		$T_{vj}=125^{\circ}\text{C}$	-	0.17	-				
		$T_{vj}=150^{\circ}\text{C}$	-	0.22	-				
		$T_{vj}=175^{\circ}\text{C}$	-	0.27	-				

(*1) Turn on time (t_{on}) = $t_{d(on)} + t_r$, Turn off time (t_{off}) = $t_{d(off)} + t_f$

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Items	Symbols	Conditions	Characteristics			Units	
			min.	typ.	max.		
Inverter Switching loss (per pulse)	E_{on}	$V_{CC} = 600V$ $I_C, I_F = 35A \quad L_s = 30nH$ $V_{GE} = +15/-15 V$ $R_G = 30 \Omega$	$T_{vj}=25^\circ C$	-	3.02	-	mJ
			$T_{vj}=125^\circ C$	-	4.16	-	
			$T_{vj}=150^\circ C$	-	4.48	-	
			$T_{vj}=175^\circ C$	-	4.77	-	
	E_{off}	$V_{CC} = 600V$ $I_C, I_F = 35A \quad L_s = 30nH$ $V_{GE} = +15/-15 V$ $R_G = 30 \Omega$	$T_{vj}=25^\circ C$	-	2.49	-	
			$T_{vj}=125^\circ C$	-	3.09	-	
			$T_{vj}=150^\circ C$	-	3.26	-	
			$T_{vj}=175^\circ C$	-	3.35	-	
	E_{rr}	$V_{CC} = 600V$ $I_C, I_F = 35A \quad L_s = 30nH$ $V_{GE} = +15/-15 V$ $R_G = 30 \Omega$	$T_{vj}=25^\circ C$	-	0.91	-	
			$T_{vj}=125^\circ C$	-	1.68	-	
			$T_{vj}=150^\circ C$	-	1.98	-	
			$T_{vj}=175^\circ C$	-	2.32	-	
Zero Gate voltage collector current	I_{CES}	$V_{GE} = 0V$ $V_{CE} = 1200V$	-	-	50	μA	
Gate-Emitter leakage current	I_{GES}	$V_{CE} = 0V, \quad V_{GE} = +20/-20V$	-	-	100	nA	
Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	$V_{GE} = 15V$ $I_C = 25A$	$T_{vj}=25^\circ C$	-	1.60	2.05	V
			$T_{vj}=25^\circ C$	-	1.50	1.95	
	$V_{CE(sat)}$ (chip)		$T_{vj}=125^\circ C$	-	1.85	-	
			$T_{vj}=150^\circ C$	-	1.95	-	
Internal Gate resistance	r_g	-	$T_{vj}=25^\circ C$	-	0	-	Ω
			$T_{vj}=175^\circ C$	-	2.00	-	
Brake Switching time (*1)	$t_{d(on)}$	$V_{CC} = 600V$ $I_C = 25A \quad L_s = 30nH$ $V_{GE} = +15/-15 V$ $R_G = 36 \Omega$	$T_{vj}=25^\circ C$	-	0.09	-	μs
			$T_{vj}=125^\circ C$	-	0.10	-	
			$T_{vj}=150^\circ C$	-	0.10	-	
			$T_{vj}=175^\circ C$	-	0.10	-	
	t_r	$V_{CC} = 600V$ $I_C = 25A \quad L_s = 30nH$ $V_{GE} = +15/-15 V$ $R_G = 36 \Omega$	$T_{vj}=25^\circ C$	-	0.04	-	
			$T_{vj}=125^\circ C$	-	0.04	-	
			$T_{vj}=150^\circ C$	-	0.04	-	
			$T_{vj}=175^\circ C$	-	0.04	-	
	$t_{d(off)}$	$V_{CC} = 600V$ $I_C = 25A \quad L_s = 30nH$ $V_{GE} = +15/-15 V$ $R_G = 36 \Omega$	$T_{vj}=25^\circ C$	-	0.23	-	
			$T_{vj}=125^\circ C$	-	0.26	-	
			$T_{vj}=150^\circ C$	-	0.27	-	
			$T_{vj}=175^\circ C$	-	0.27	-	
	t_f	$V_{CC} = 600V$ $I_C = 25A \quad L_s = 30nH$ $V_{GE} = +15/-15 V$ $R_G = 36 \Omega$	$T_{vj}=25^\circ C$	-	0.11	-	
			$T_{vj}=125^\circ C$	-	0.20	-	
			$T_{vj}=150^\circ C$	-	0.22	-	
			$T_{vj}=175^\circ C$	-	0.23	-	
Reverse current	I_{RRM}	$V_R = 1200V$	-	-	50	μA	
Forward voltage	V_F (terminal)	$I_F = 15A$	$T_{vj}=25^\circ C$	-	1.90	2.35	V
			$T_{vj}=25^\circ C$	-	1.80	2.25	
	V_F (chip)		$T_{vj}=125^\circ C$	-	1.85	-	
			$T_{vj}=150^\circ C$	-	1.80	-	
			$T_{vj}=175^\circ C$	-	1.75	-	
Converter Reverse current	I_{RRM}	$V_R = 1600V$	-	-	50	μA	
			Forward voltage	V_{FM}	terminal	-	1.20
chip	-	1.05			1.50		
Thermistor Resistance	R	$T = 25^\circ C$	-	5000	-	Ω	
		$T = 100^\circ C$	465	495	520		
B value	B	$T = 25/ 50^\circ C$	3305	3375	3450	K	

(*1) Turn on time (t_{on}) = $t_{d(on)} + t_r$, Turn off time (t_{off}) = $t_{d(off)} + t_f$

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NOTICE:

The external gate resistance (R_G) shown above is one of our recommended value for the purpose of minimum switching loss. However the optimum R_G depends on circuit configuration and/or environment. We recommend that the R_G has to be carefully chosen based on consideration if IGBT module matches design criteria, for example, switching loss, EMC/EMI, spike voltage, surge current and no unexpected oscillation and so on.

□Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance (1device)	$R_{th(j-c)}$	Inverter IGBT	-	-	0.74	°C/W
		Inverter FWD	-	-	0.86	
		Brake IGBT	-	-	0.88	
		Brake FWD	-	-	1.85	
		Converter Diode	-	-	0.87	
Contact thermal resistance (1 IGBT+1 FWD) (*1)	$R_{th(c-f)}$	with 1 W/(m·K) thermal grease	-	0.05	-	

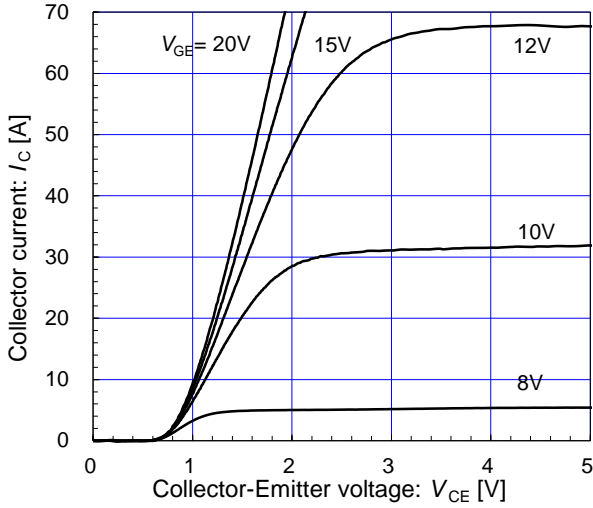
(*1) This is the value which is defined mounting on the additional cooling fin with thermal grease.

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[Inverter]

Collector current vs. Collector-Emmitter voltage (typ.)

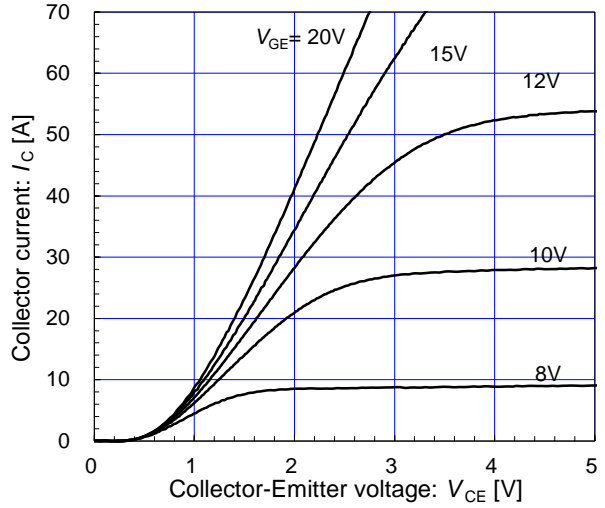
$T_{vj} = 25^\circ\text{C}$ / chip



[Inverter]

Collector current vs. Collector-Emmitter voltage (typ.)

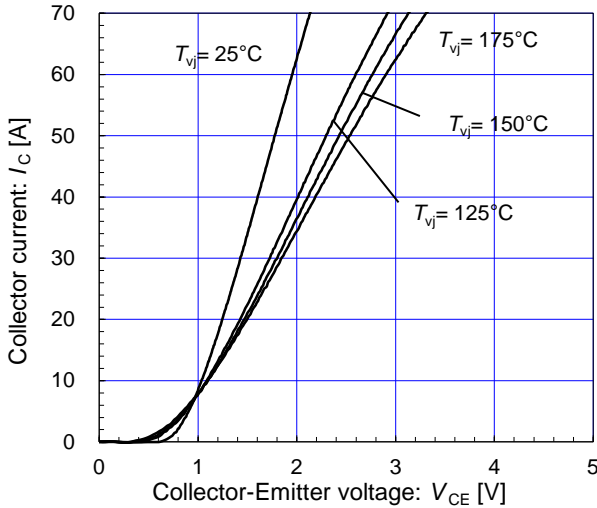
$T_{vj} = 175^\circ\text{C}$ / chip



[Inverter]

Collector current vs. Collector-Emmitter voltage (typ.)

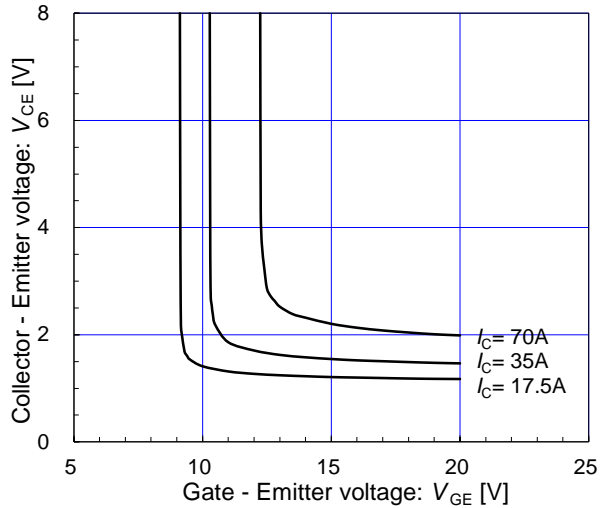
$V_{GE} = 15\text{V}$ / chip



[Inverter]

Collector-Emmitter voltage vs. Gate-Emmitter voltage (typ.)

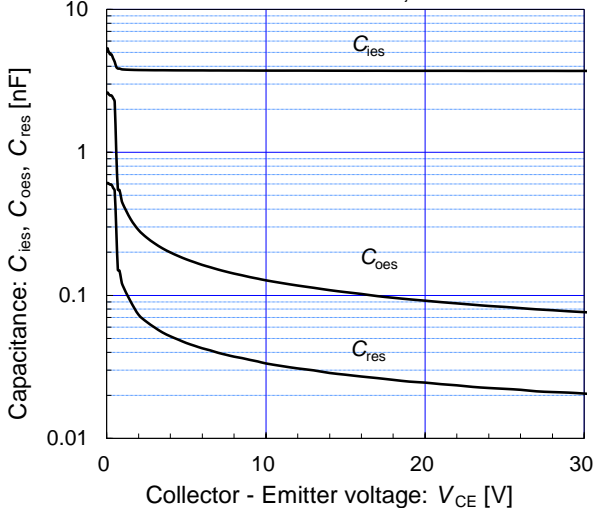
$T_{vj} = 25^\circ\text{C}$ / chip



[Inverter]

Capacitance vs. Collector-Emmitter voltage (typ.)

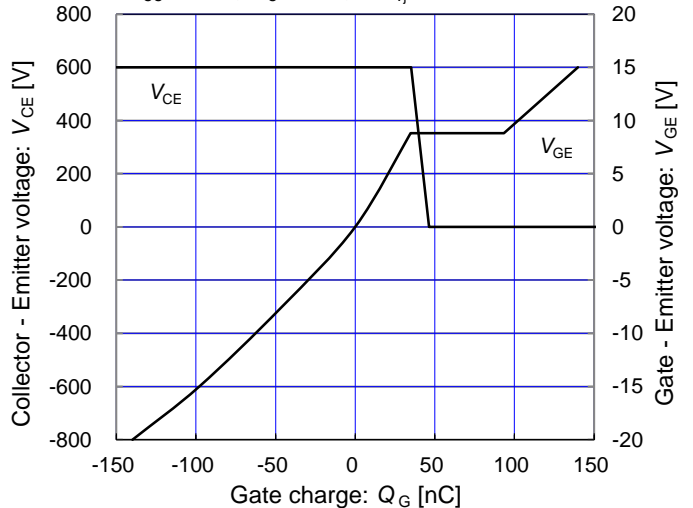
$V_{GE} = 0\text{V}$, $f = 1\text{MHz}$, $T_{vj} = 25^\circ\text{C}$



[Inverter]

Dynamic Gate charge (typ.)

$V_{CC} = 600\text{V}$, $I_c = 35\text{A}$, $T_{vj} = 25^\circ\text{C}$

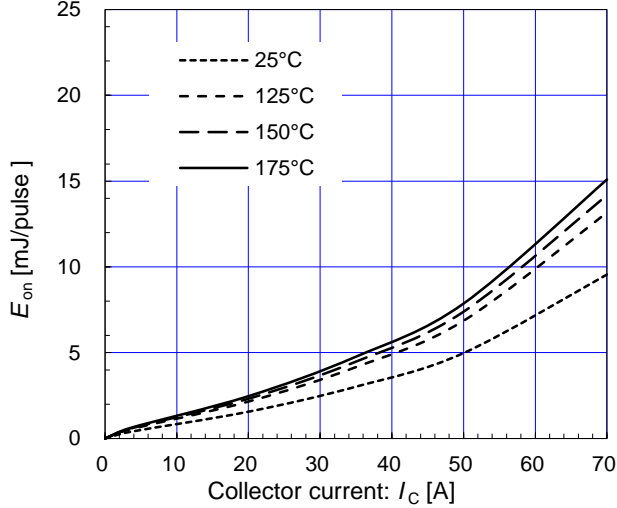


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[Inverter]

E_{on} vs. Collector current (typ.)

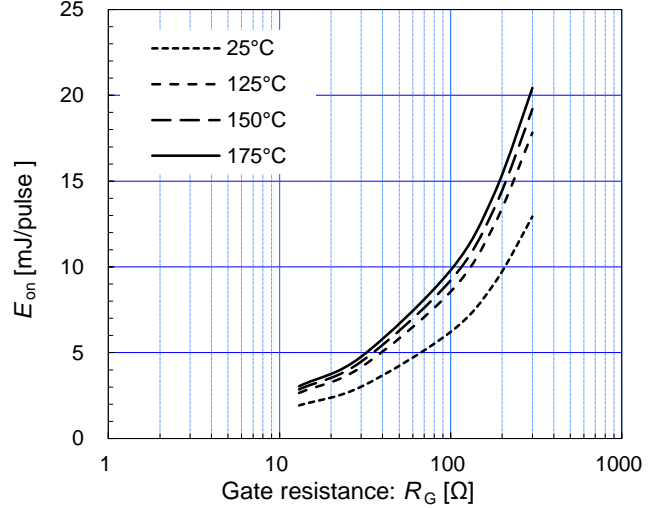
$V_{CC}= 600V, V_{GE}= +15/-15 V, R_G= 30 \Omega$



[Inverter]

E_{on} vs. Gate resistance (typ.)

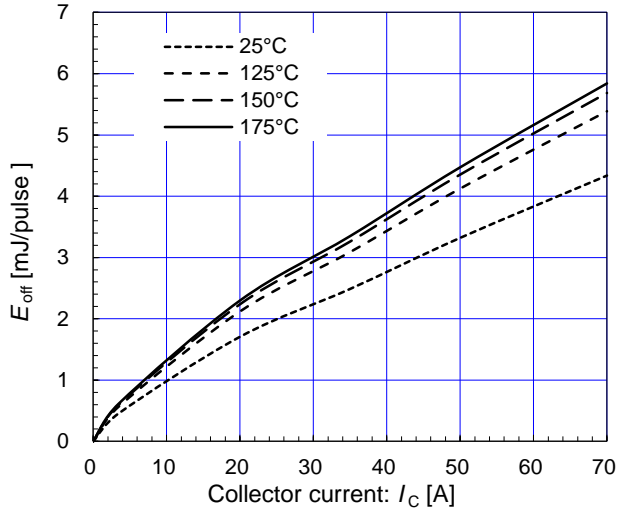
$V_{CC}= 600V, V_{GE}= +15/-15 V, I_C= 35A$



[Inverter]

E_{off} vs. Collector current (typ.)

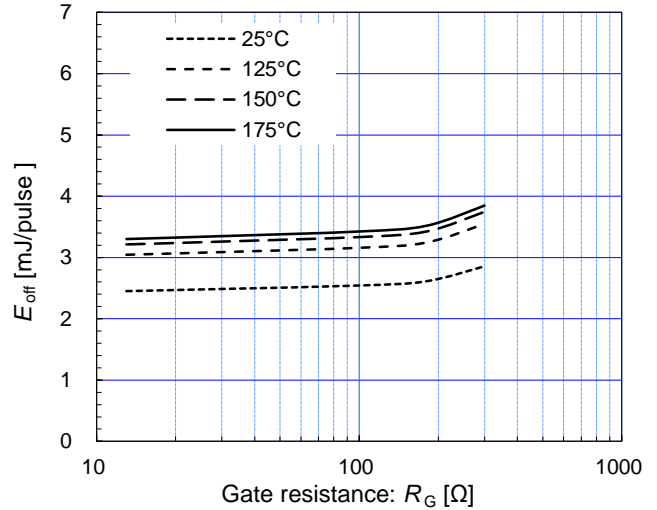
$V_{CC}= 600V, V_{GE}= +15/-15 V, R_G= 30 \Omega$



[Inverter]

E_{off} vs. Gate resistance (typ.)

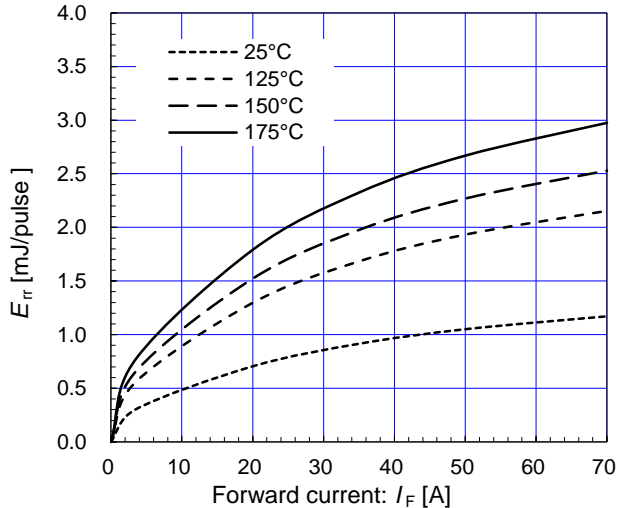
$V_{CC}= 600V, V_{GE}= +15/-15 V, I_C= 35A$



[Inverter]

E_{rr} vs. Forward current (typ.)

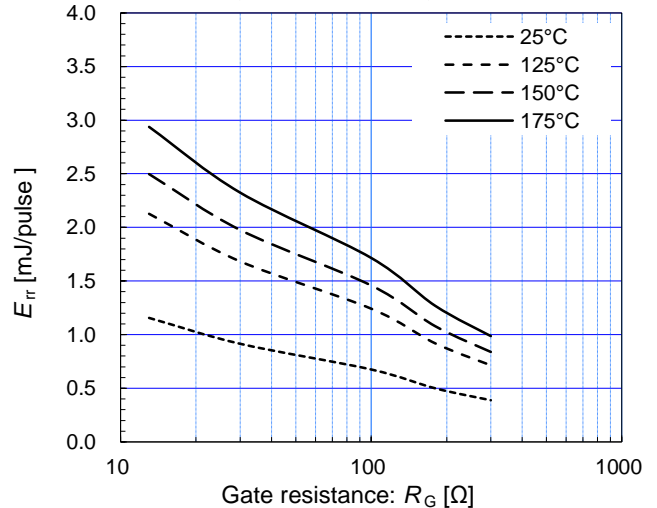
$V_{CC}= 600V, V_{GE}= +15/-15 V, R_G= 30 \Omega$



[Inverter]

E_{rr} vs. Gate resistance (typ.)

$V_{CC}= 600V, V_{GE}= +15/-15 V, I_C= 35A$

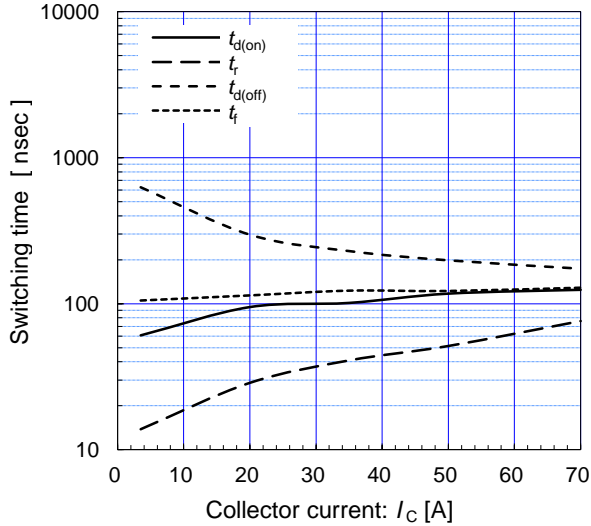


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[Inverter]

Switching time vs. Collector current (typ.)

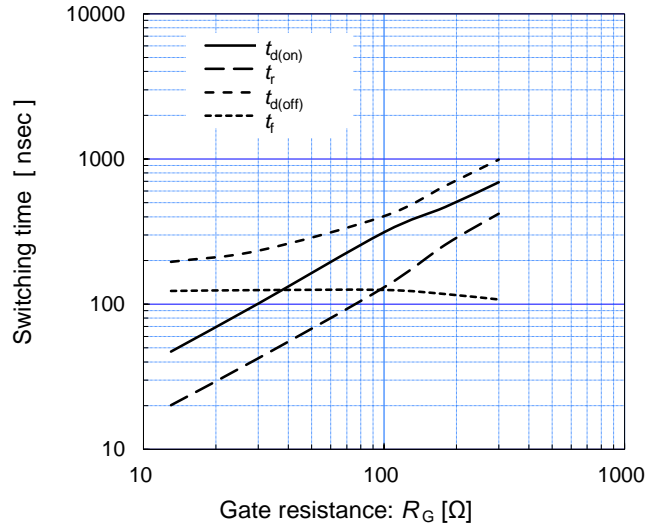
$V_{CC}= 600V, R_G= 30\Omega \quad V_{GE}= +15/-15 V, \quad T_{vj}= 25^\circ C$



[Inverter]

Switching time vs. Gate resistance (typ.)

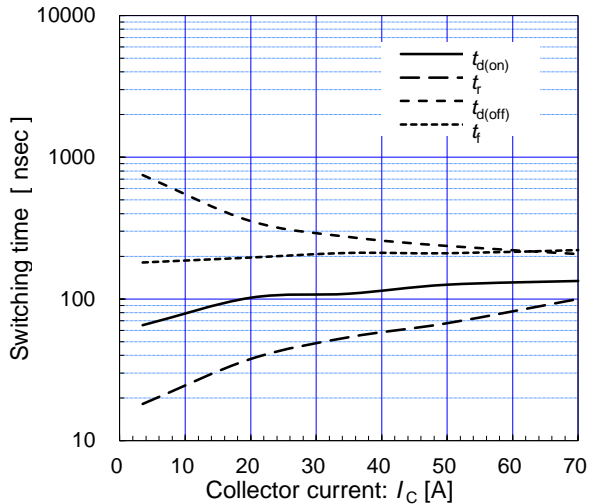
$V_{CC}= 600V, I_C= 35A, \quad V_{GE}= +15/-15 V, \quad T_{vj}= 25^\circ C$



[Inverter]

Switching time vs. Collector current (typ.)

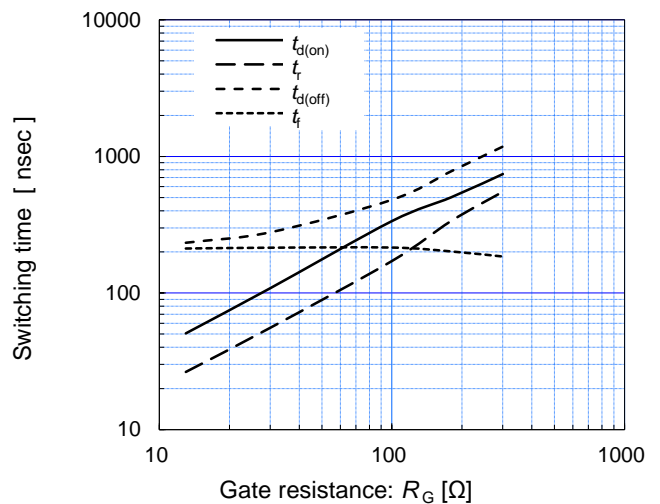
$V_{CC}= 600V, R_G= 30\Omega \quad V_{GE}= +15/-15 V, \quad T_{vj}= 175^\circ C$



[Inverter]

Switching time vs. Gate resistance (typ.)

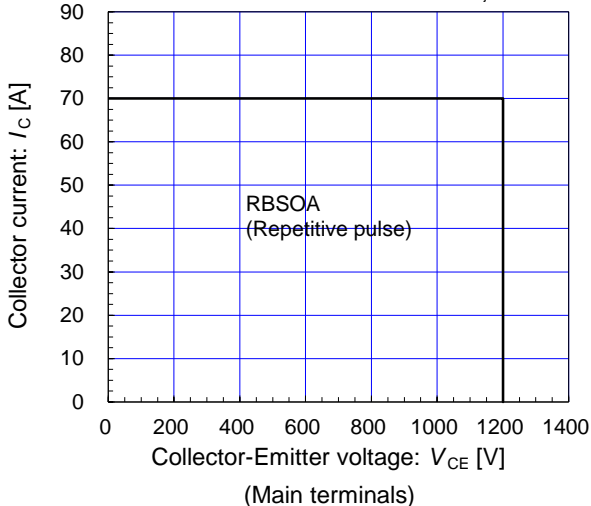
$V_{CC}= 600V, I_C= 35A, \quad V_{GE}= +15/-15 V, \quad T_{vj}= 175^\circ C$



[Inverter]

Reverse bias safe operating area (max.)

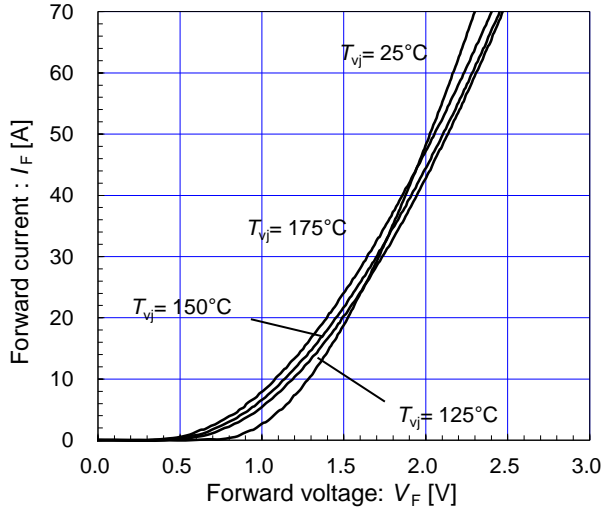
$V_{GE}= +15/-15 V, \quad R_G \geq 30\Omega \quad T_{vj}= 175^\circ C$



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[Inverter]

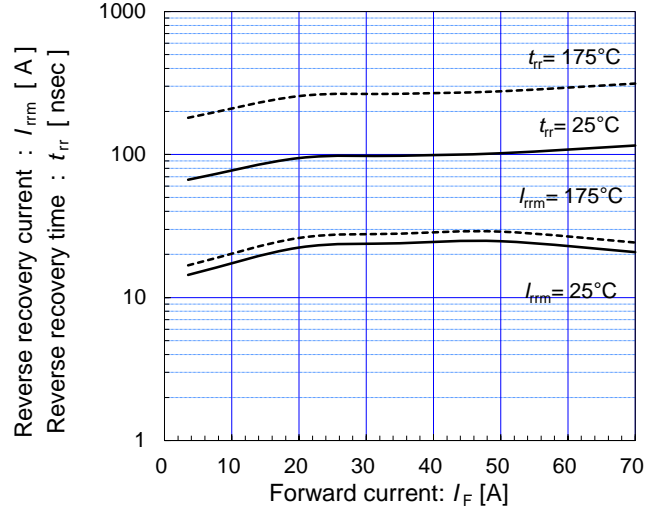
Forward current vs. Forward voltage (typ.)
chip



[Inverter]

Reverse recovery characteristics (typ.)

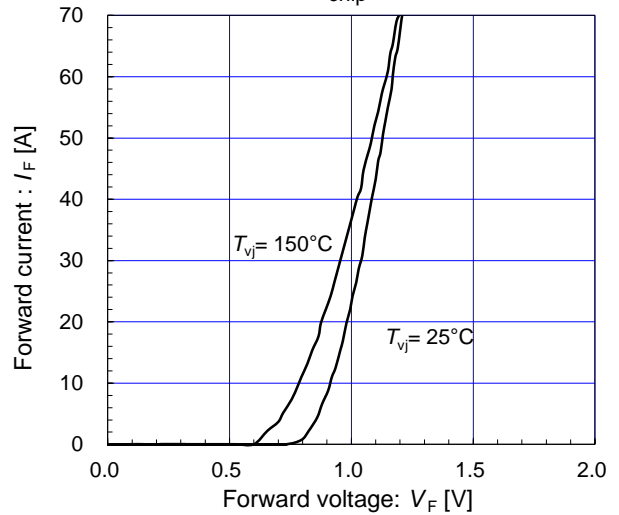
$V_{CC} = 600V, V_{GE} = +15/-15V, R_G = 30\Omega$



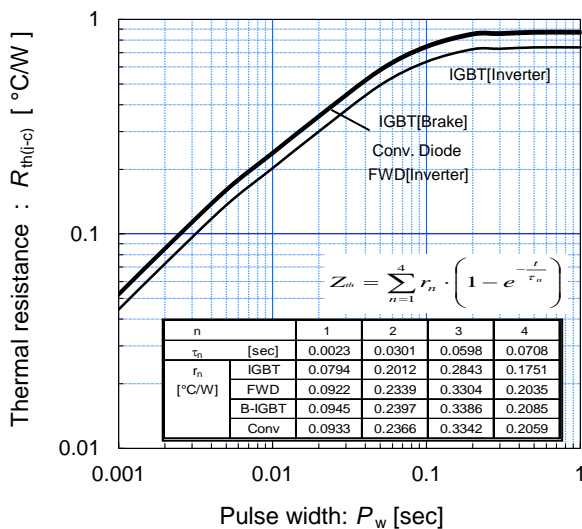
[Converter]

Forward current vs. Forward voltage (typ.)

chip

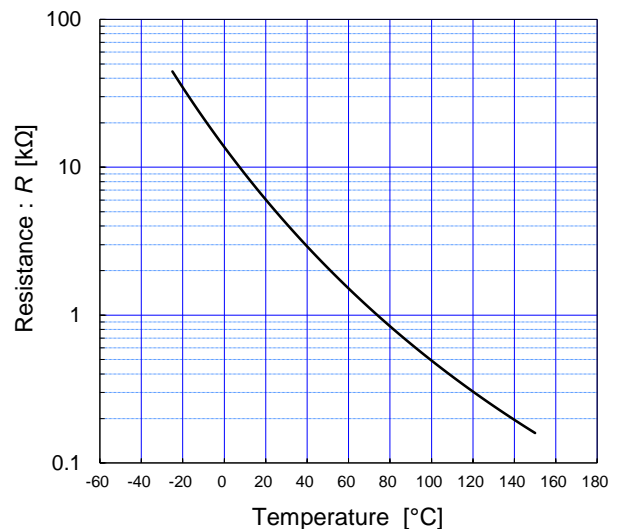


Transient thermal resistance (max.)



[Thermistor]

Temperature characteristic (typ.)

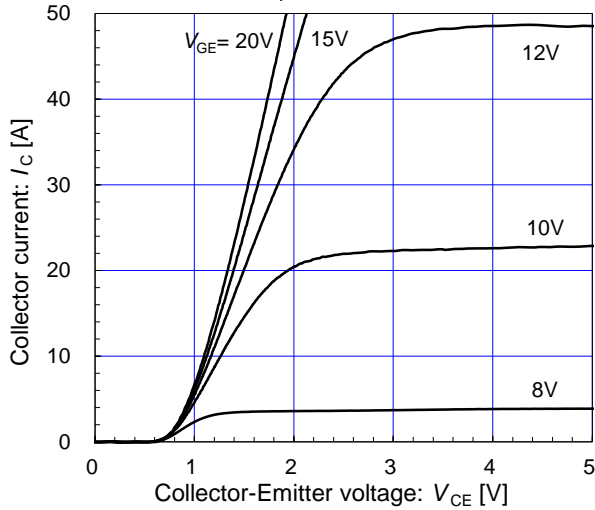


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[Brake]

Collector current vs. Collector-Emittor voltage (typ.)

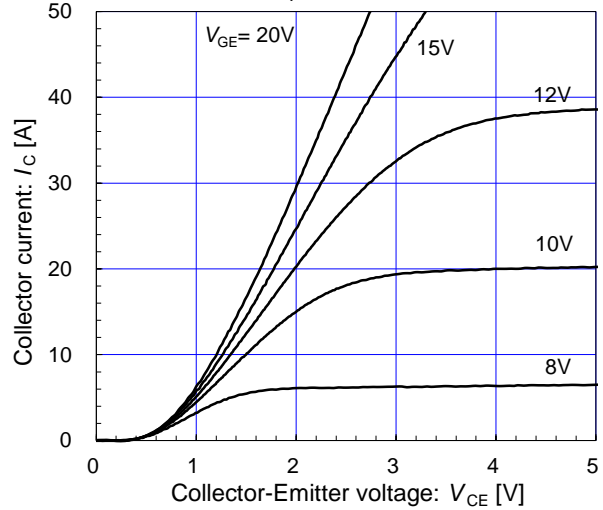
$T_{vj} = 25^{\circ}\text{C}$ / chip



[Brake]

Collector current vs. Collector-Emittor voltage (typ.)

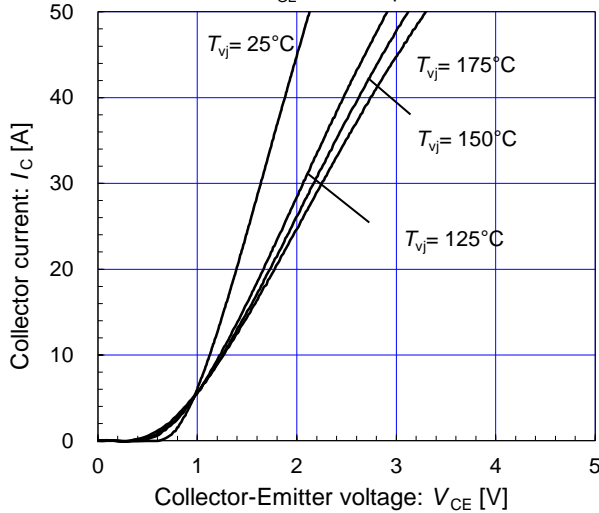
$T_{vj} = 175^{\circ}\text{C}$ / chip



[Brake]

Collector current vs. Collector-Emittor voltage (typ.)

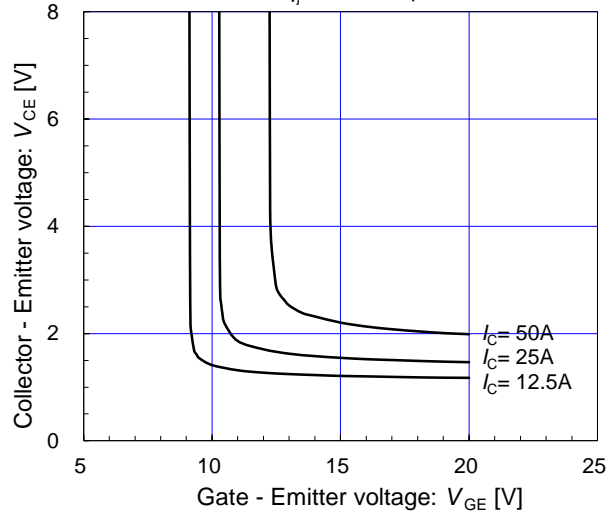
$V_{GE} = 15\text{V}$ / chip



[Brake]

Collector-Emittor voltage vs. Gate-Emittor voltage (typ.)

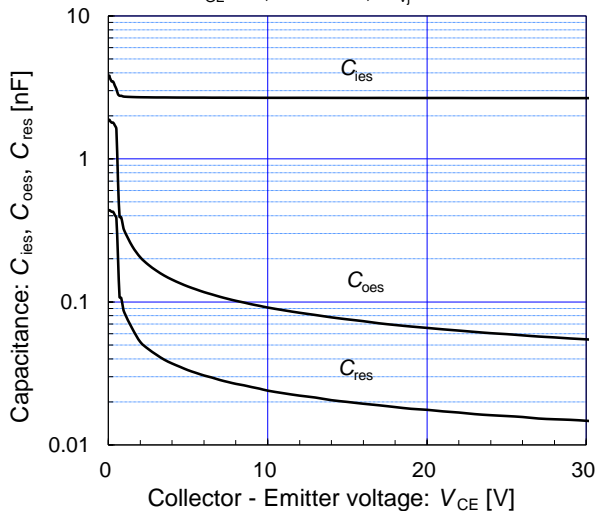
$T_{vj} = 25^{\circ}\text{C}$ / chip



[Brake]

Capacitance vs. Collector-Emittor voltage (typ.)

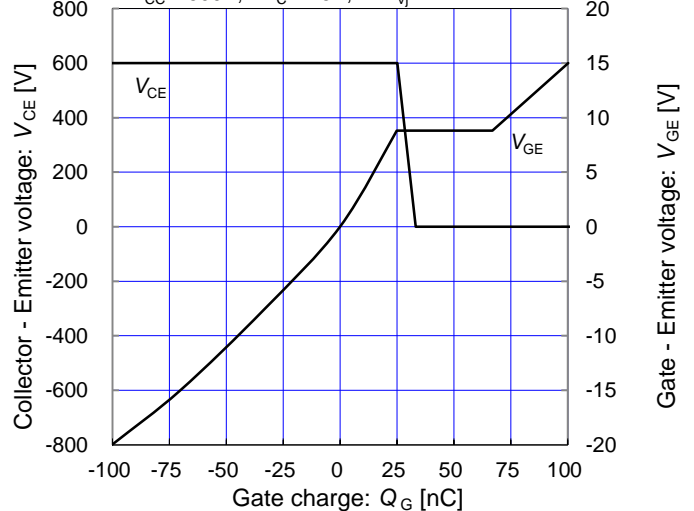
$V_{GE} = 0\text{V}$, $f = 1\text{MHz}$, $T_{vj} = 25^{\circ}\text{C}$



[Brake]

Dynamic Gate charge (typ.)

$V_{CC} = 600\text{V}$, $I_C = 25\text{A}$, $T_{vj} = 25^{\circ}\text{C}$



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